●特点：导通电阻低　　开关速度快　　输入阻抗高　　符合RoHS规范

●**FEATURES**：■LOW ON-RESISTANCE ■FAST SWITCHING ■HIGH INPUT RESISTANCE ■RoHS COMPLIANT

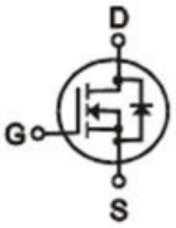
●应用：电子镇流器　　电子变压器　　开关电源

●**APPLICATION**: ■ELECTRONIC BALLAST■ELECTRONIC TRANSFORMER■SWITCH MODE POWER SUPPLY

●**最大额定值（Tc=25°C）**

●**Absolute Maximum Ratings（Tc=25°C）**　　**TO-251/251S/252/252T**

参数 PARAMETER	符号 SYMBOL	额定值 VALUE	单位 UNIT
漏-源电压 Drain-source Voltage	V_{DS}	800	V
栅-源电压 gate-source Voltage	V_{GS}	±30	V
漏极电流 Continuous Drain Current TC=25℃	I_D	3.0	A
漏极电流 Continuous Drain Current TC=100℃	I_D	1.3*	A
最大脉冲电流 Drain Current －Pulsed ①	I_{DM}	8*	A
耗散功率 Power Dissipation	P_D	25	W
最高结温 Junction Temperature	Tj	150	°C
存储温度 Storage Temperature	T_{STG}	-55-150	°C
单脉冲雪崩能量 Single Pulse Avalanche Energy ②	E_{AS}	120	mJ

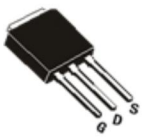


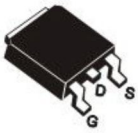
V_{DS}=800V

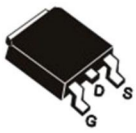
$R_{DS(ON)}$=4.3Ω

I_D=3.0A


TO-251(IPAK)


TO-251S


TO-252(DPAK)


TO-252T

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature

●**电特性（Tc=25°C）**

●**Electronic Characteristics（Tc=25°C）**

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
漏-源击穿电压 Drain-source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA	800			V
击穿电压温度系数 Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta Tj$	I_D=250uA, Referenced to 25°C		0.6		V/°C
栅极开启电压 Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS}=V_{DS}, I_D=250μA	3.0		5.0	V
漏-源漏电流 Drain-source Leakage Current	I_{DSS}	V_{DS} =800V, V_{GS} =0V, Tj=25°C			1	μA
		V_{DS} =640V, V_{GS} =0V, Tj=125°C			10	μA
跨导 Forward Transconductance	gfs	V_{DS} =40V, I_D=1.0A ③		2.5		S

参数 PARAMETER	符号 SYMBOL	测试条件 TEST CONDITION	最小值 MIN	典型值 TYP	最大值 MAX	单位 UNIT
栅极漏电流 Gate-body Leakage Current (V_{DS} = 0)	I_{GSS}	V_{GS} =±30V			±100	nA
漏-源导通电阻 Static Drain-source On Resistance	$R_{DS(ON)}$	V_{GS} =10V, I_D=1.0A ③		4.3	5.5	Ω
输入电容 Input Capacitance	Ciss	V_{GS} = 0V, V_{DS} = 25V F = 1.0MHZ		370		pF
输出电容 Output Capacitance	Coss			30		
反向传输电容 Reverse transfer Capacitance	Crss			7		
关断延迟 Turn -Off Delay Time	Td(off)	V_{DD}=400V, I_D =2.0A R_G=25Ω ③		35		ns
栅极电荷 Total Gate Charge	Qg	I_D =2.0A, V_{DS} = 640V V_{GS} = 10V ③		8.7		nC
栅源电荷 Gate-to-Source Charge	Qgs			2.2		nC
栅漏电荷 Gate-to-Drain Charge	Qgd			3.0		nC
二极管正向电流 Continuous Diode Forward Current	I_S				3.0	A
二极管正向压降 Diode Forward Voltage	V_{SD}	Tj=25°C, Is=2.0A V_{GS} =0V ③			1.4	V
反向恢复时间 Reverse Recovery Time	trr	Tj=25°C, If=2.0A di/dt=100A/μs ③		370		ns
反向恢复电荷 Reverse Recovery Charge	Qrr			3.6		uC

●热特性
●Thermal Characteristics

参数 PARAMETER	符号 SYMBOL	最大值 MAX	单位 UNIT
热阻结-壳 Thermal Resistance Junction-case	Rth_{JC}	5.0	℃/W
热阻结-环境 Thermal Resistance Junction-ambient	Rth_{JA}	83.3	℃/W

注释(Notes):

① 脉冲宽度：以最高结温为限制

Repetitive rating: Pulse width limited by maximum junction temperature

② 初始结温=25ºC, V_{DD} =50V, L=57mH, R_G =25Ω, I_{AS}=4.0A

Starting Tj=25ºC, V_{DD} =50V, L=57mH, R_G =25Ω, I_{AS}=4.0A

③ 脉冲测试：脉冲宽度≤ 300μs ， 占空比≤ 2 %

Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%

● 特性曲线

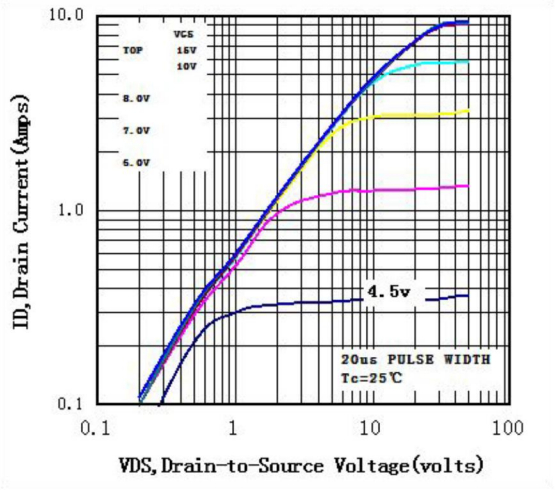


图 1 输出特性曲线, Tc=25℃

Fig1 Typical Output Characteristics, Tc=25℃

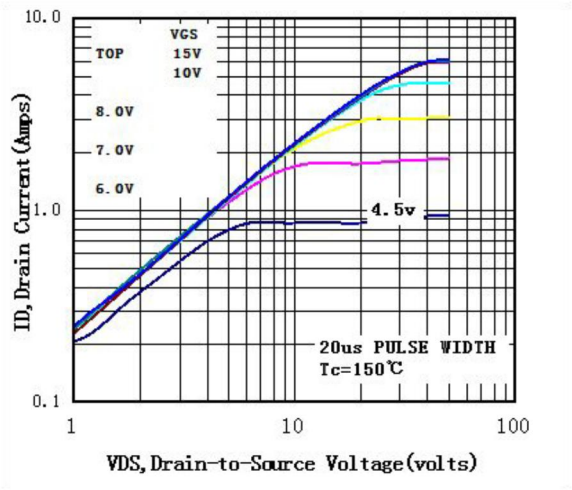


图 2 输出特性曲线, Tc=150℃

Fig2 Typical Output Characteristics, Tc=150℃

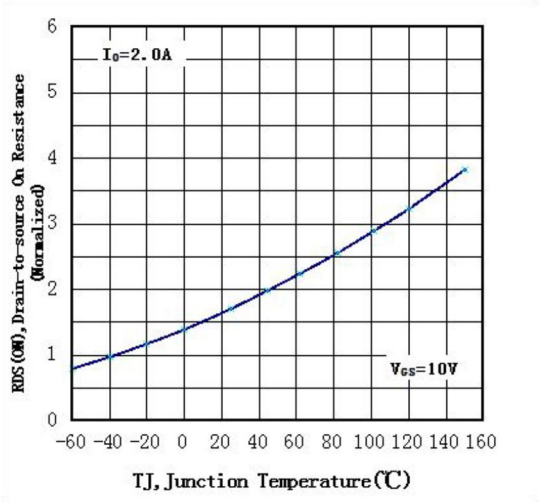


图 3 归一化导通电阻与温度曲线

Fig3 Normalized Resistance Vs.Temperature

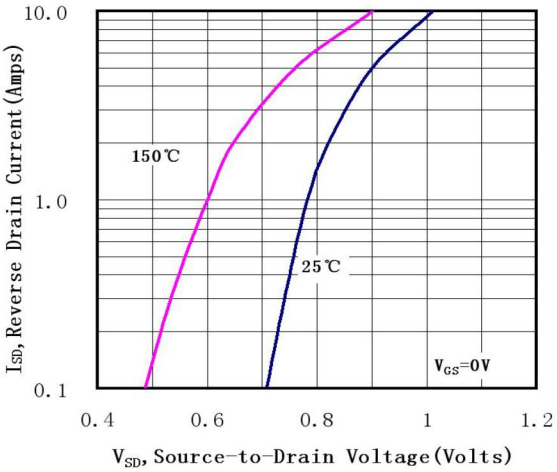


图 4 二极管正向电压曲线

Fig4 Typical Source-Drain Diode Forward Voltage

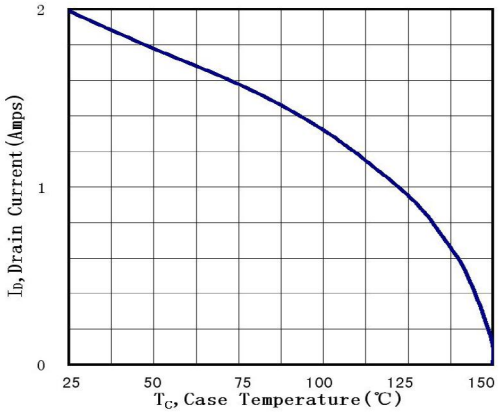


图 5 最大漏极电流与壳温曲线

Fig5 Maximum Drain Current Vs.Case Temperature

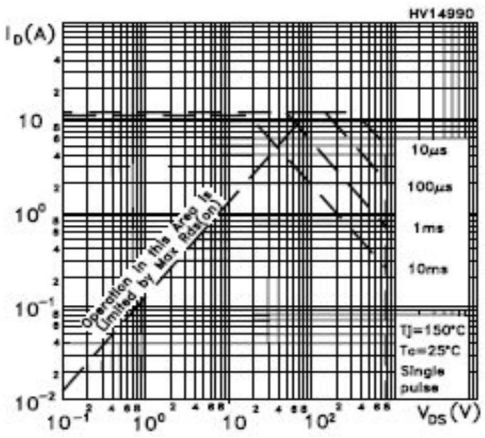


图 6 最大安全工作区曲线

Fig6 Maximum Safe Operating Area